Electronic Patent Application Fee Transmittal								
Application Number:	09	09546174						
Filing Date:	11-Apr-2000							
Title of Invention:	HIGH DENSITY PLASMA CHEMICAL VAPOR DEPOSITION PROCESS							
First Named Inventor/Applicant Name:	Cł	Chih-Chien Liu						
Filer:	William H. Wright/Lillian Rodriguez							
Attorney Docket Number:	JIA 462C1							
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Utility Filing Fees								
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)			
Basic Filing:								
Pages:								
Claims:								
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Patent-Appeals-and-Interference:								
Notice of appeal		1401	1	510	510			
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
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